



# CER1226A - Preliminary

## 2450-3170MHz Bandpass Filter

### Features

- Low Loss with High Rejection
- Low Group Delay Variation

### Applications

- Primarily for Radio Altimeter applications

### Description

Surface mount ceramic bandpass filter. Superior rejection, insertion loss, reliability, as well as both peak and average power handling compared other bandpass filter technologies.

### Electrical Specifications

Parameter	Frequency (MHz)	Typical at 25°C	Spec. at 25°C	Spec. over -40°C to +85°C
Nominal Impedance	-	50 ohms	-	-
Average Input Power	-	-	-	5.0 Watt max
Peak Input Power	-	-	-	50 Watt max
Input-Output Response				
Passband Insertion Loss	2450-3170	1.2 dB	1.8 dB max	2.0 dB max
Passband Ripple	2450-3170	0.5 dB	0.8 dB max	0.9 dB max
Passband Return Loss	2450-3170	12 dB	10 dB min	10 dB min
GDV over any 120MHz in Passband	2450-3170	0.9 ns	1.2 ns max	1.2 ns max
Attenuation:	1-2000	58 dB	55 dB min	55 dB min
	3500	45 dB	40 dB min	40 dB min
	3600-7000	55 dB	50 dB min	50 dB min

Note: CTS tests each unit to the critical specifications above. Subsequent audits may deviate due to repeatability among different test systems which shall not exceed these allowances.

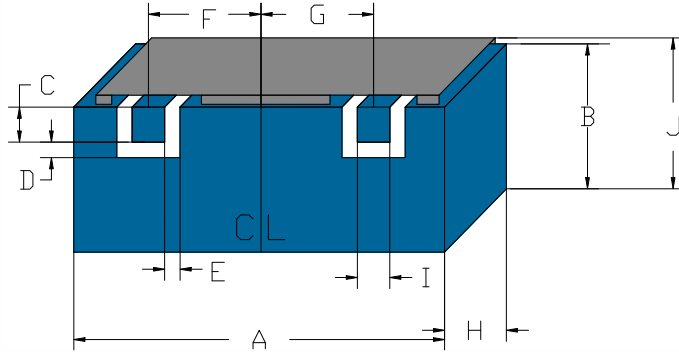
#### Specification Allowance

Insertion Loss	0.1 dB
Return Loss	1.0 dB
Attenuation	1.0 dB

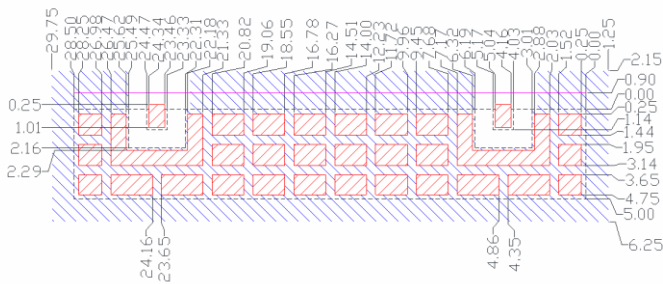


Part Dimensions: 28.5 × 6.2 × 6.1 mm • 3.2 g  
Materials: Ag plated ceramic block with brass shield

### Mechanical Drawing



### PCB Layout

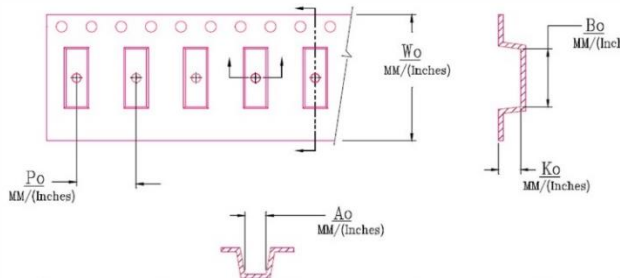


- Shield
- Filter Outline
- Exposed Conductor
- Solder Resist Over Dielectric
- Solder Resist Over Conductor

### Packaging and Marking

Dimension	Units	Spec.	Product Marking
Reel Diameter	mm	330	<div>CTS</div> <div>1226</div> <div>YYWW</div>
Reel Weight	kg	2.6	
Reel Quantity	ea.	500	

Customer Feed Direction → → →



$W_0$	$A_0$	$B_0$	$K_0$	$P_0$
1.732 in 44.0 mm	0.240 in 6.10 mm	1.134 in 28.80 mm	0.252 in 6.40 mm	0.472 in 12.0 mm

Dim.	Nominal (mm)	Tolerance (±mm or Max)
A	28.5	max
B	5.00	max
C	1.14	0.13
D	1.02	0.13
E	1.02	0.13
F	9.65	0.13
G	9.65	0.13
H	6.10	max
I	1.14	0.13
J	6.20	max

**IMPORTANT:** Please assure  $\geq 30$  mils (0.75mm) thickness of dielectric beneath the I/O Pads and the surrounding clearance zone down to the required ground plane.

Please assure sufficient ground vias between the top metal ground plane and the primary ground plane.

Recommended solder: 4-6 mils of SAC305 with reflow including 120s of soak at 217°C, and up to 30 sec peak at 241°C.

### Electrical Response

